
APPLICATION DATA SHEET

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Representative Information:

Representative Customer Number:	26530
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Application Information:

Title:	MULTI-CHIP PACKAGE AND METHOD FOR MANUFACTURING THE SAME
Total Drawing Sheets:	14
Docket:	CU-3609 RJS
Application Type:	Utility

Continuity Information:

This application is a:	Division of U.S. Serial No. 10/338,202 filed January 8, 2003
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Prior Foreign Applications:

Application:	2002-22113
Filing Date:	April 23, 2002
Country:	Republic of Korea
Priority Claimed:	YES